# RUIL&N

### SMD3216 Series

H S F

#### Description

The SMD3216 series has been especially designed to meet data transmission protection requirements. The optimized design features a high level of protection against fast rising transients usually caused by lightning disturbances. For use in high frequency data lines, the series offers ultra low capacitances and shows only marginally signal losses up to high frequencies. The devices are extremely reliable and are able to withstand high surge currents without destruction.



## **Electrical symbol**



#### Features

- I Excellent response to fast rising transients
- I Stable breakdown voltage
- I GHz working frequency
- I 8/20µs Impulse current capability: 500A
- I Surface Mount package
- I Non-Radioactive
- I Ultra Low capacitance(<0.3pF) and insertion loss
- I Very Small Size(EIA 1206)
- I Storage and operational temperature: -40~+90°C

### **Applications**

- I Ethernet, PoE, xDSL
- I Cable modem, splitters, line cards
- I Wireless antenna protection
- I CATV equipment
- I Switching power supply

### **Part Number Code**



Specifications are subject to change without notice. Please refer to http://www.ruilon.com.cn for current information.

Version: A3/2023-11-02 File Number: SP-GDT-001



## SMD3216 Series

## **Electrical Characteristics**

Part Number	DC Spark-over Voltage <sup>1) 2)</sup> @100V/S	Impulse Spark-over Voltage		Insulation Resistance	Capacitance	Glow Voltage	Arc Voltage	Service life		
								Impulse Discharge		Impulse Withstanding
		100V/µS	1KV/µS	3)	@1 MHz	@10mA	@1A	Current @8/20µS		Voltage Capacity @10/700µS, 40W
		Max	Max	Min	Мах	Typical	Typical	±5 times	1 time	±5 times
	v	v	v	GΩ	pF	v	v	A	Α	KV
SMD3216-090N	90±30%	500	600	1	0.3	60	10	500		6
SMD3216-150N	150±30%	500	600	1	0.3	60	10	500		6
SMD3216-200N	200±30%	600	700	1	0.3	60	10	500		6
SMD3216-230N	230±30%	600	700	1	0.3	60	10	500		6
SMD3216-300N	300±30%	700	800	1	0.3	60	10	500		6
SMD3216-350N	350±30%	750	850	1	0.3	60	10	500		6
SMD3216-400N	400±30%	800	900	1	0.3	60	10	500		6
SMD3216-420N	420±30%	850	950	1	0.3	60	10	500		6
SMD3216-470N	470±30%	900	1000	1	0.3	60	10	500		6
SMD3216-600N	600±30%	1000	1200	1	0.3	60	10	500		6
Glow to Arc transition Current				<0.1A	<0.1A					
Weight				~0.03g	~0.03g					
Operation and storage temperature				40~+9	-40~+90°C					
Climatic category (IEC 60068-1)				40/90/2	40/90/21					
Marking				Withou	Without					
Surface treatment				Matte-t	Matte-tin plated					
Moisture sensitivity level <sup>4)</sup>				1						

<sup>1)</sup> At delivery AQL 0.65 level II, DIN ISO 2859.

<sup>2)</sup> In ionized mode.

<sup>3)</sup> Insulation Resistance Measuring Voltage:

75V~150V at DC 50V

Other at DC 100V

<sup>4)</sup> Tests according to JEDEC J-STD-020.

Terms in accordance with ITU-T K.12, IEC 61643-311, GB/T 9043, GB/T18802.311.

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## SMD3216 Series

HSF

## Dimensions





Recommended Soldering Pad Layout

## **Packaging Information**



#### **Reel Specifications**



#### **Packaging Quantity:**

- 2,000 PCS per reel (7") 4 reels per inner box
- 8,000 PCS per inner box



#### Direction of Unreeling

Symbol	Millimeters	Inches
Α	1.6±0.2	0.063±0.008
В	1.6±0.2	0.063±0.008
С	3.2±0.3	0.126±0.012
D	0.3±0.1	0.012±0.004
х	1.3	0.051
X1	3.3	0.130
Y	1.8	0.071

Symbol	Millimeters	Inches
w	12±0.3	0.472±0.012
A0	1.86±0.1	0.073±0.004
B0	3.6±0.1	0.142±0.004
K0	1.7±0.1	0.067±0.004
Р	4.0±0.1	0.157±0.004
F	5.5±0.1	0.217±0.004
E	1.75±0.1	0.069±0.004
D	1.5+0.1/-0.0	0.059+0.004/-0.0
P0	4±0.1	0.157±0.004
P2	2±0.1	0.079±0.004
т	0.35±0.05	0.014±0.002
D0	13.3±0.15	0.524±0.006
D1	178±2	7.007±0.079
D2	60+1/-2	2.362+0.039/-0.079
W1	12.5±0.4	0.492±0.016

# RUIL

## Gas Discharge Tubes (GDT)

## SMD3216 Series

## Soldering Parameters - Reflow Soldering (Surface Mount Devices)



Reflow Condit	Pb - Free assembly			
	-Temperature Min (T <sub>s(min)</sub> )	150°C		
Preheat	-Temperature Max (T <sub>s(max)</sub> )	200°C		
	- Time (min to max) (t <sub>s</sub> )	60 -180 Seconds		
Average ramp to peak	up rate ( Liquids Temp $T_L$ )	3°C/second max		
T <sub>S(max)</sub> to TL - Ramp-up Rate		5°C/second max		
Reflow	- Temperature (T <sub>L</sub> ) (Liquids)	217°C		
	- Time (min to max) (t <sub>s</sub> )	60 -150 Seconds		
Peak Temperature (T <sub>P</sub> )		260 +0/-5°C		
Time within 5°C of actual peak Temperature ( $t_p$ )		10 - 30 Seconds		

Surface mounted components (SMD) may exhibit a temporary increase in the DC spark-over voltage after the solder reflow process. The components will recover within 24 hours. There is no quality defect nor change in protection levels during the temporary change in DC spark-over voltage.

## **Terms and definitions**

NO.	Item	Definitions
		A gap, or several gaps, in an enclosed discharge medium, other than air at atmospheric pressure,
1	Gas discharge tube(GDT)	designed to protect apparatus or personnel, or both, from high transient voltages. Also referred to as
		"gas tube surge arrester".
2	DC Spark-over Voltage	The voltage at which the gas discharge tube sparks over with slowly increasing d.c. voltage.
3	Impulse Spark-over	The highest voltage which appears across the terminals of a gas discharge tube in the period between
Ŭ	Voltage	the application of an impulse of given wave-shape and the time when current begins to flow.
5	Arc voltage	Voltage drop across the GDT during arc current flow.
6	Glow voltage	Peak value of voltage drop across the GDT when a glow current is flowing.
	Impulse discharge	
7	current	Current impulse with a nominal virtual front time of 8 $\mu$ s and a nominal time to half-value of 20 $\mu$ s.
	8/20µs	
8	Alternating	The rms value of an approximately sinusoidal alternating current passing through the gas discharge
	Discharge Current	tube.
9	Insulation	Insulation resistance shall be measured from each terminal to every other terminal of the GDT. The test
	Resistance	is performed with DC50V when normal spark-over Voltage 70~150V, others with DC100V.
10	Capacitance	The capacitance shall be measured once at 1 MHz between all terminals unless otherwise specified.

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## Gas Discharge Tubes (GDT)

## SMD3216 Series

## **Cautions and warnings**

- I Do not operate surge arresters in power supply networks, whose maximum operating voltage exceeds the minimum spark-over voltage of the surge arresters.
- I Surge arresters may become hot in the event of longer periods of current stress (burn risk). In the event of overload the connectors may fail or the component may be destroyed.
- I Surge arresters must be handled with care and must not be dropped.
- I Do not continue to use damaged surge arresters.
- I The shown SMD pad dimensions represent a safe way to mount the arrester and are a recommendation of the manufacturer. During the reflow process it must be assured that no solder material reduces the insulation distance between the pads below the arrester.
- I SMD surge arresters should be soldered within 24 month after shipment.

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 WPGT-2N145B6L
 WPGT-2N230B6L
 WPGT-2N470B6L
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 WPGT-2R1000B8L
 WPGT-2N90B6L
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 SD09-V24 9
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